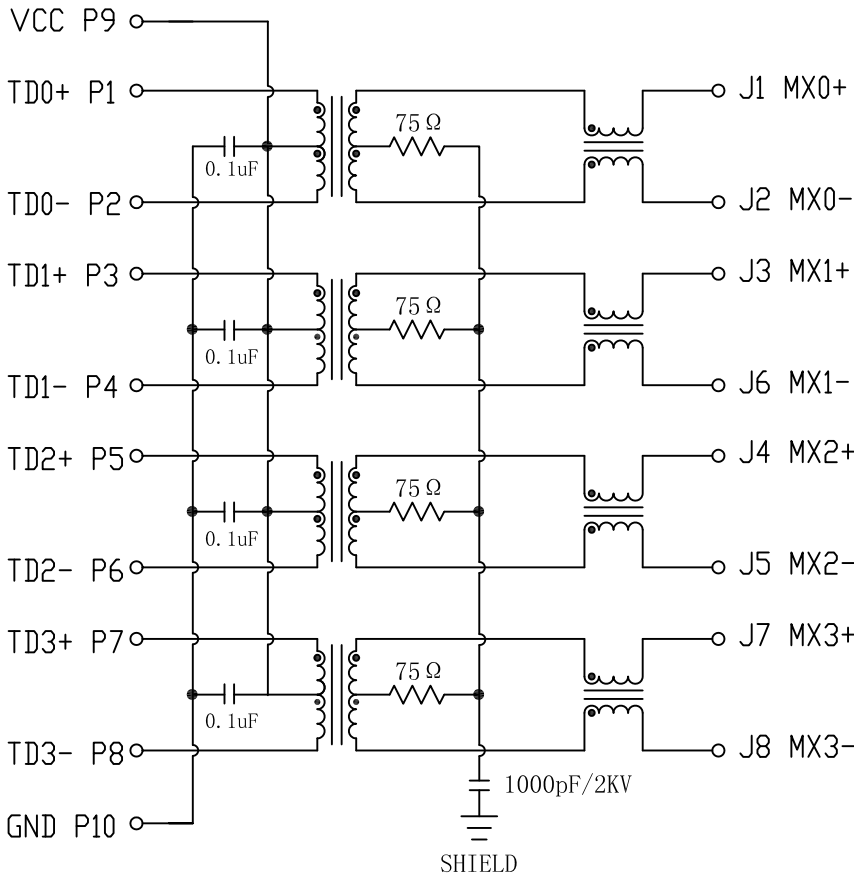


Schematic:

REV.	ECN NO.	DESCRIPTION	DATE	APPD
A	REL		2011/11/25	

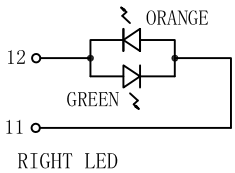
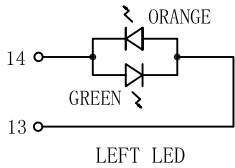
PCB CONNECTIONS



RJ45 CONNECTOR

Electrical Specifications @25°C

- Turns Ratio:
PRI:SEC = 1CT:1CT ±2%
- OCL:
350uH MIN @100KHz, 100mV, 8mADC
- Insertion Loss:
1~100MHz:-1.0dB MAX
- Return Loss(dB MIN):
1~30MHz:-18 30~60MHz:-14
60~80MHz:-12
- Crosstalk(dB TYP):
1~30MHz:-40 30~60MHz:-35
60~80MHz:-30
- Differential to Common Mode Rejection:
1~50MHz: -30dB TYP
50~150MHz: -20dB TYP
- CMRR: 1~100MHz:-30dB MIN
- Isolation: 1500Vrms MIN
- Operating Temperature Range: -20°C~+70°C.

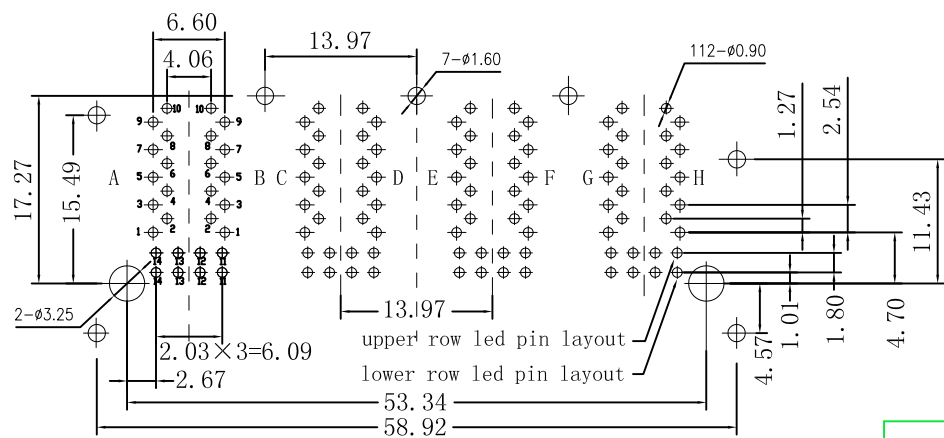
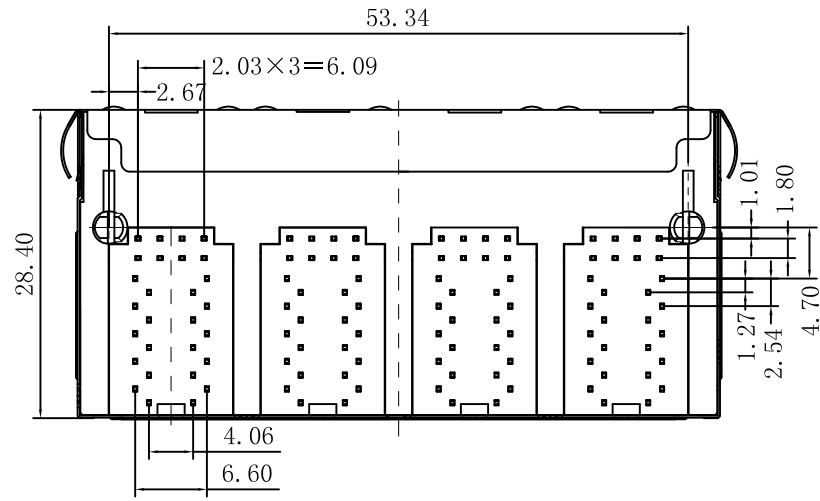
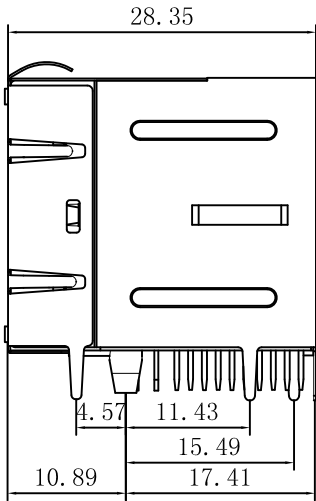
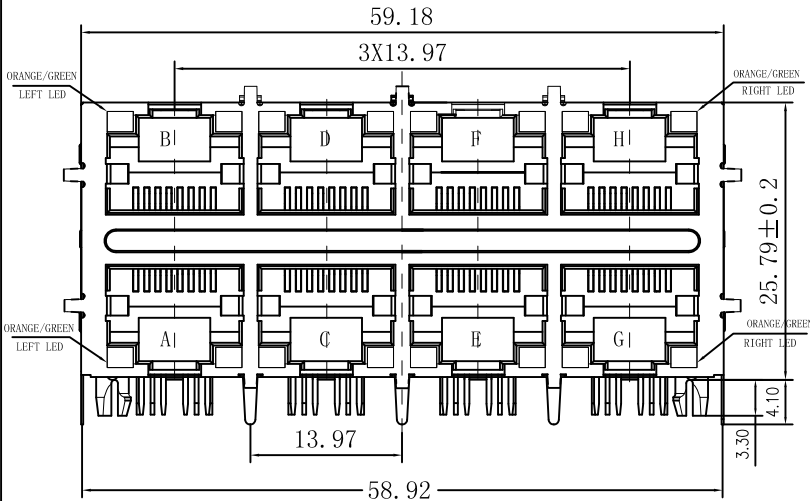


Emitting Color	λ p(nm)	VF@IF=20mA	IR @VR=5V
ORANGE/GREEN	610/565	1.8~2.6V	10 μ A max



X:X	±0.30	APPD:	LINK-PP INT'L TECHNOLOGY CO., LIMITED	
X:XX	±0.25	CHKD:		
X:XXX	±0.05	DR: TOM	TITLE: RJ45 .Transformer. 1000 Base-T . 2×4	
ANGLES	±1°	UNIT: mm	PART NO.: LPJG47561A55NL	
	SCALE: 2/1	SHEET: 1/2	REV: A	DWG NO.: LP11112519

Mechanical :



SUGGESTED PCB LAYOUT (TOP VIEW)



- NOTES:
1. Designed to support application, such as SOHO (ADSL modems), LAN-on-Motherboard (LOM), hub and Switches.
 2. Meets IEEE 802.3 specification
 3. Connector Materials:
Housing: Thermoplastic UL94V-0
Contact/Shield: Copper alloy
Shield plating: Nickel
Contact plating: Gold 6 micro-inches min. In contact area.
 4. Wave solder tip temperature: 265°C Max, 5 Sec Max.

REV.	ECN NO.	DESCRIPTION	DATE	APPD
A	REL		2011/11/25	

X:X	±0.30	APPD:	LINK-PP INT'L TECHNOLOGY CO., LIMITED	
X:XX	±0.25	CHKD:		
X:XXX	±0.05	DR: TOM	TITLE: RJ45 .Transformer. 1000 Base-T . 2×4	
ANGLES	±1°	UNIT: mm	PART NO.: LPJG47561A55NL	
	SCALE: 2/1	SHEET: 2/2	REV: A	DWG NO.: LP11112519